Page 1

Declaration and Power of Attorney for Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DICING AND DIE BONDING PRESSURE-SENSITIVE ADHESIVE SHEET AND PROCESS FOR PRODUCING SEMICONDUCTOR DEVICES

The sp	ecification of v	which			•			
.	is attached h	ereto.						
0	was filed on							
	as Application Serial No.							
	and was amended on							
×	(if applicable) was filed as PCT international application							
	No. PC	CT/JP2004/9629	onJuly 7, 2004		- ·			
	and was ame	and was amended under PCT Article 19 on						
	(if applicable)							
I herel	oy state that I	have reviewed and under as amended by any amend	erstand the contents of the above-id	entified sp	ecification,			
includi	,	as anienada sy any aniena	anent referred to above.		•			
I ackno	owledge the du		which is material to the patentability	of this ap	plication in			
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I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Page 2

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the practitioners associated with

Customer Number 28289

to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith.

Customer Number 28289 identifies the law firm of **WEBB ZIESENHEIM LOGSDON ORKIN AND HANSON, P.C.** whose address is 700 Koppers Building, 436 Seventh Avenue, Pittsburgh, Pennsylvania 15219-1818, Telephone No. 412-471-8815

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